Band Switching Diode

#### DA2S00100L

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**Panasonic** 

### Silicon epitaxial planar type

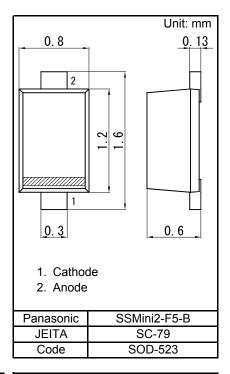
#### For band switching

#### ■ Features

- · Low forward dynamic resistance rf
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: D1

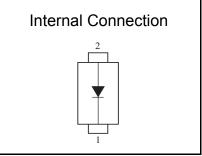
#### ■ Packaging

Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)



■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit	
Reverse voltage	VR	40	V	
Forward current	IF	100	mA	
Junction temperature	Tj	150	°C	
Operating ambient temperature	Topr	-40 to +85	°C	
Storage temperature	Tstg	-55 to +150	°C	



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■ Electrical Characteristics Ta = 25 °C ± 3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	VF	IF = 100 mA		0.92	1.0	V
Reverse current	IR	VR = 40 V			100	nA
Diode capacilance	CD	VR = 6 V, f = 1 MHz		0.9	1.2	pF
Forward dynamic resistance *1	rf	IF = 2 mA, f = 100 MHz		0.65	0.85	Ω

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.

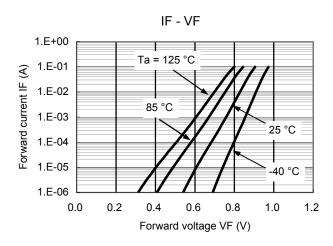
2. \*1 Measure YHP MODL 4191A RF IMPEDANCE ANALYZER Standard frequency of input and output is 100MHz.

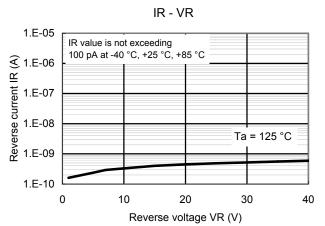
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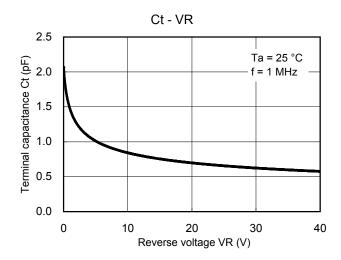
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## **Panasonic**

### Technical Data (reference)







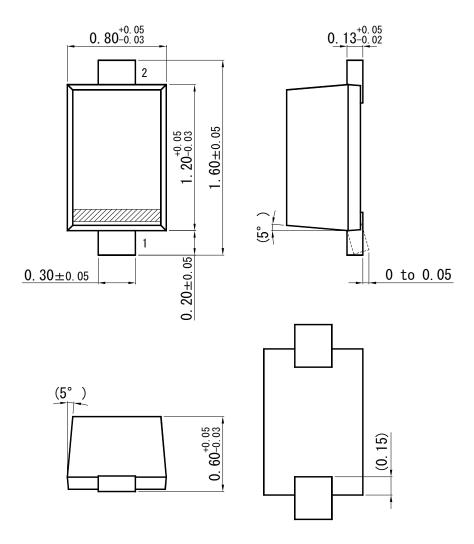
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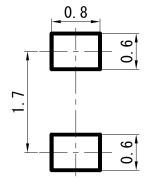
## **Panasonic**

SSMini2-F5-B

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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